

$V_{DSM} = 2800\text{ V}$
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 $I_{TAVM} = 1400\text{ A}$
 $I_{TRMS} = 2210\text{ A}$
 $I_{TSM} = 18000\text{ A}$
 $V_{T0} = 0.82\text{ V}$
 $r_T = 0.370\text{ m}\Omega$

Phase Control Thyristor

5STP 16F2800

Doc. No. 5SYA1022-03 Sep. 01

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability

Blocking

Part Number	5STP 16F2800	5STP 16F2600	5STP 16F2200	Conditions
V_{DRM} V_{RRM}	2800 V	2600 V	2200 V	$f = 50\text{ Hz}$, $t_p = 10\text{ ms}$
V_{RSM1}	3000 V	2800 V	2400 V	$t_p = 5\text{ ms}$, single pulse
I_{DRM}	$\leq 200\text{ mA}$			V_{DRM} $T_j = 125^\circ\text{C}$
I_{RRM}	$\leq 200\text{ mA}$			V_{RRM}
dV/dt_{crit}	1000 V/ μs			Exp. to $0.67 \times V_{DRM}$, $T_j = 125^\circ\text{C}$

Mechanical data

F_M	Mounting force	nom.	22 kN
		min.	14 kN
		max.	24 kN
a	Acceleration		
	Device unclamped		50 m/s ²
	Device clamped		100 m/s ²
m	Weight		0.6 kg
D_S	Surface creepage distance		25 mm
D_a	Air strike distance		14 mm

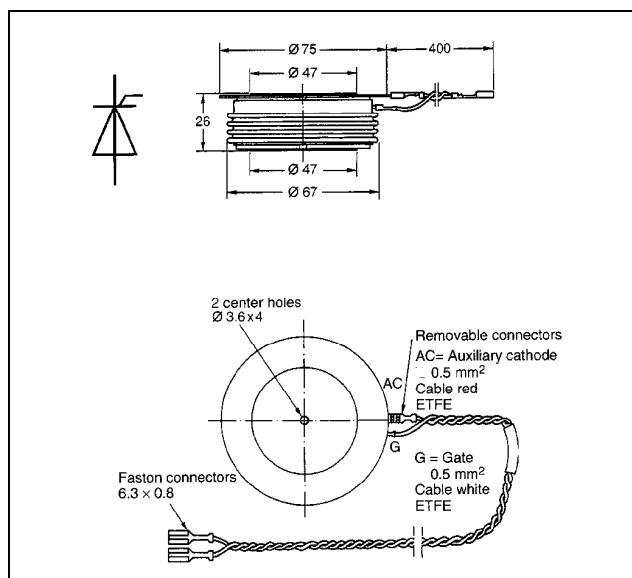


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On-state

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I_{TAVM}	Max. average on-state current	1400 A	Half sine wave, $T_C = 70^{\circ}\text{C}$	
I_{TRMS}	Max. RMS on-state current	2210 A		
I_{TSM}	Max. peak non-repetitive	18000 A	$t_p =$ 10 ms	$T_j = 125^{\circ}\text{C}$
	surge current	19000 A	$t_p =$ 8.3 ms	After surge:
I^2t	Limiting load integral	1620 kA^2s	$t_p =$ 10 ms	$V_D = V_R = 0\text{V}$
		1498 kA^2s	$t_p =$ 8.3 ms	
V_T	On-state voltage	1.55 V	$I_T =$ 2000 A	$T_j = 125^{\circ}\text{C}$
V_{T0}	Threshold voltage	0.82 V	$I_T =$ 800 - 2400 A	
r_T	Slope resistance	0.370 $\text{m}\Omega$		
I_H	Holding current	25-75 mA	$T_j = 25^{\circ}\text{C}$	
		15-60 mA	$T_j = 125^{\circ}\text{C}$	
I_L	Latching current	100- mA	$T_j = 25^{\circ}\text{C}$	
		50-200 mA	$T_j = 125^{\circ}\text{C}$	

Switching

di/dt_{crit}	Critical rate of rise of on-state current	150 A/ μs	Cont. $f = 50\text{ Hz}$	$V_D \leq 0.67 \cdot V_{DRM}$, $T_j = 125^\circ\text{C}$ $I_{TRM} = 2000\text{ A}$ $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu\text{s}$
		300 A/ μs	60 sec. $f = 50\text{ Hz}$	
t_d	Delay time	$\leq 3.0\text{ }\mu\text{s}$	$V_D = 0.4 \cdot V_{DRM}$	$I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu\text{s}$
t_q	Turn-off time	$\leq 400\text{ }\mu\text{s}$	$V_D \leq 0.67 \cdot V_{DRM}$ $dv_D/dt = 20\text{ V}/\mu\text{s}$	$I_{TRM} = 2000\text{ A}$, $T_j = 125^\circ\text{C}$ $V_R > 200\text{ V}$, $di_T/dt = -20\text{ A}/\mu\text{s}$
Q_{rr}	Recovery charge	min 3000 μAs		
		max 6000 μAs		

Triggering

V_{GT}	Gate trigger voltage	2.6 V	$T_j = 25^\circ$
I_{GT}	Gate trigger current	400 mA	$T_j = 25^\circ$
V_{GD}	Gate non-trigger voltage	0.3 V	$V_D = 0.4 \times V_{DRM}$
I_{GD}	Gate non-trigger current	10 mA	$V_D = 0.4 \times V_{DRM}$
V_{FGM}	Peak forward gate voltage	12 V	
I_{FGM}	Peak forward gate current	10 A	
V_{RGM}	Peak reverse gate voltage	10 V	
P_G	Gate power loss	3 W	

Thermal

Max. operating junction temperature 5STP 16F2800 5STP 16F2800 供应商		125 °C	
Storage temperature range T_{stg}		-40...140 °C	
Thermal resistance junction to case R_{thJC}		33 K/kW	Anode side cooled
		35 K/kW	Cathode side cooled
		17 K/kW	Double side cooled
Thermal resistance case to heat sink R_{thCH}		8 K/kW	Single side cooled
		4 K/kW	Double side cooled

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^n R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
R _i (K/kW)	10.35	3.76	2.29	0.67
τ _i (s)	0.3723	0.0525	0.0057	0.0023

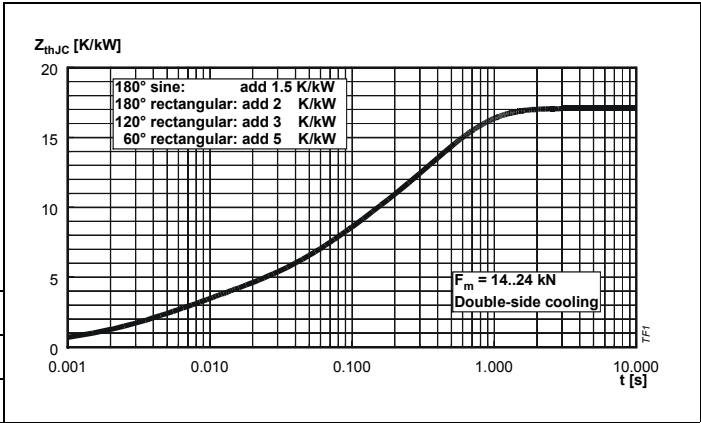


Fig. 1 Transient thermal impedance junction to case.

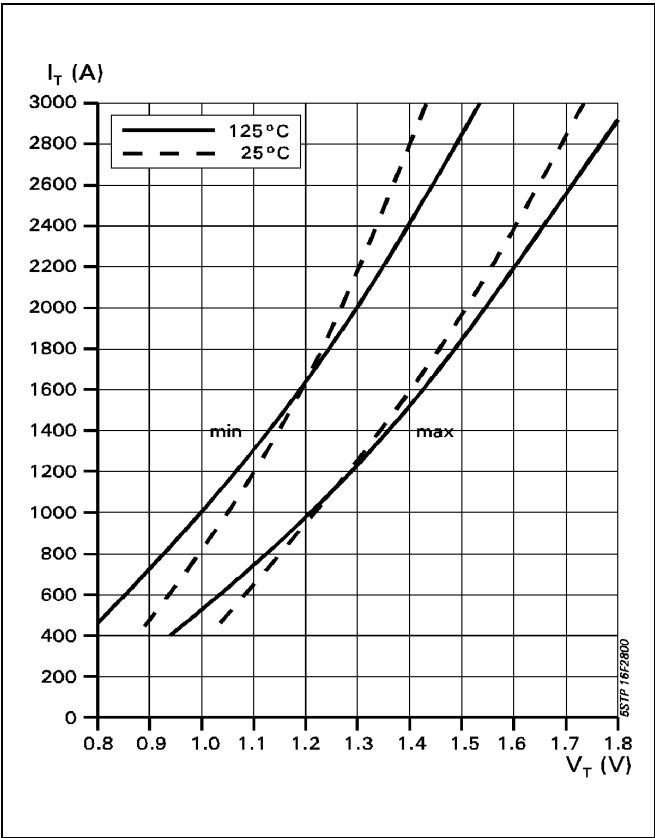


Fig. 2 On-state characteristics.

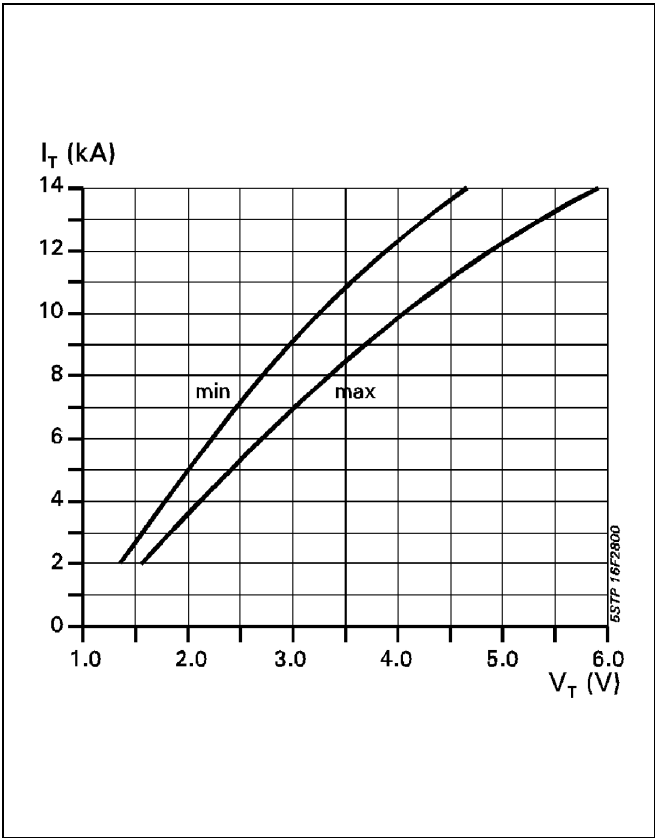


Fig. 3 On-state characteristics.
T_j=125°C, 10ms half sine

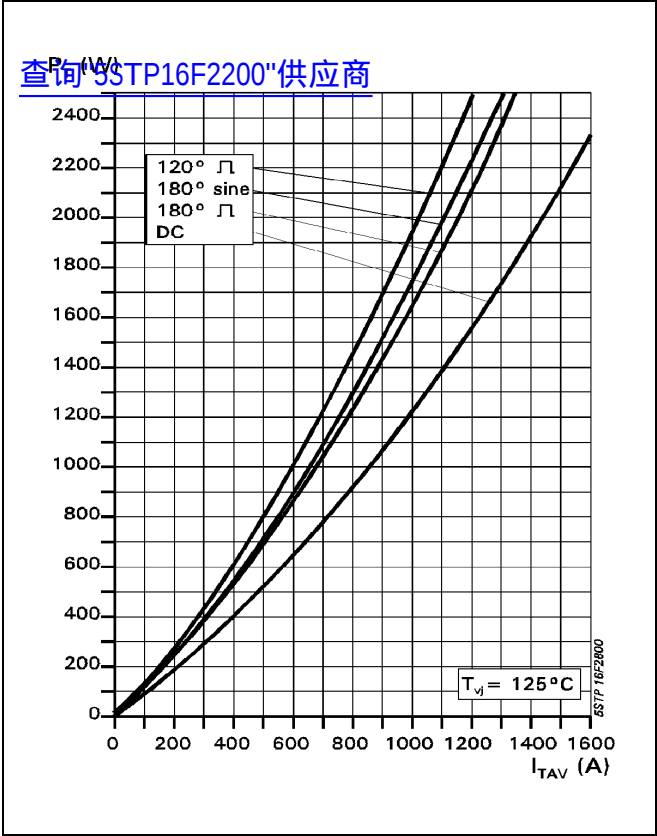


Fig. 4 On-state power dissipation vs. mean on-state current. Turn - on losses excluded.

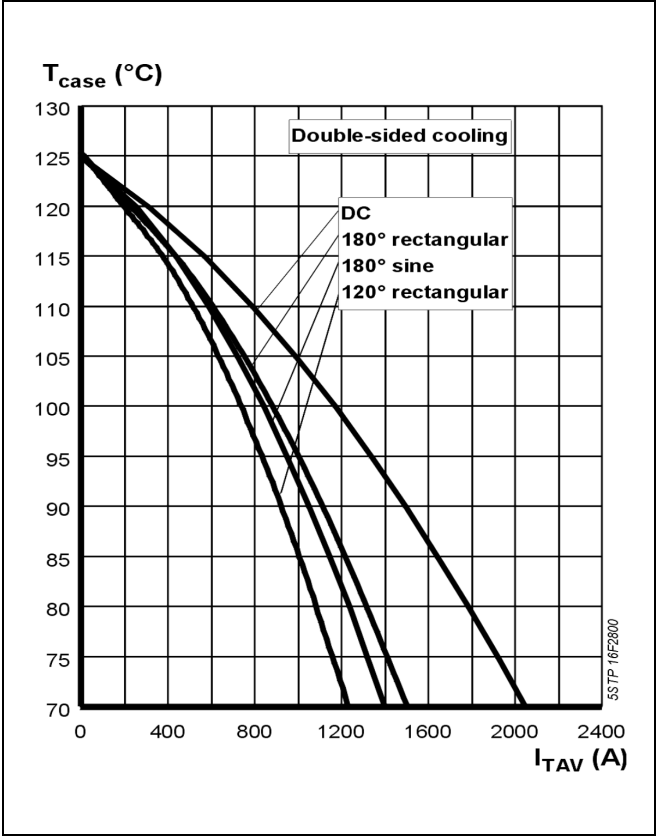


Fig. 5 Max. permissible case temperature vs. mean on-state current.

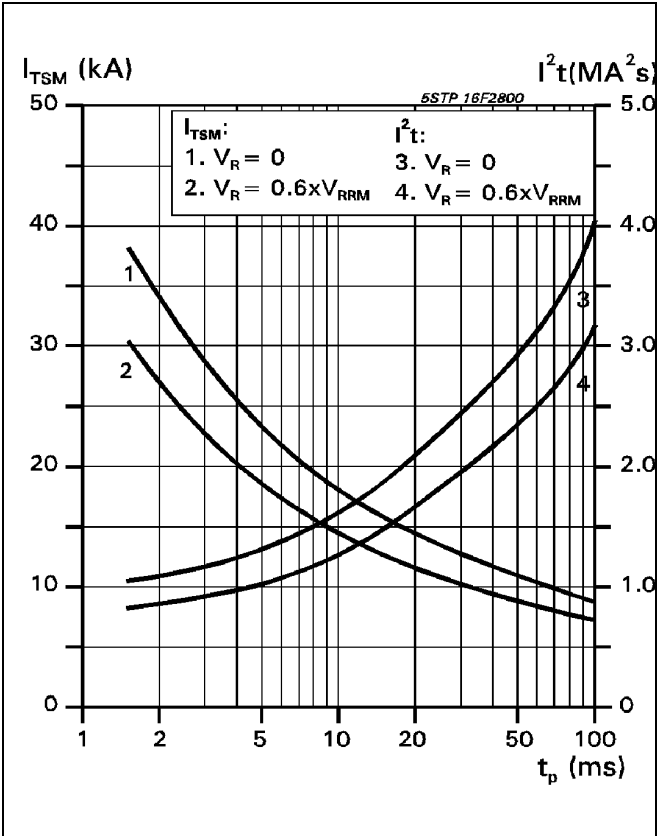


Fig. 6 Surge on-state current vs. pulse length. Half-sine wave.

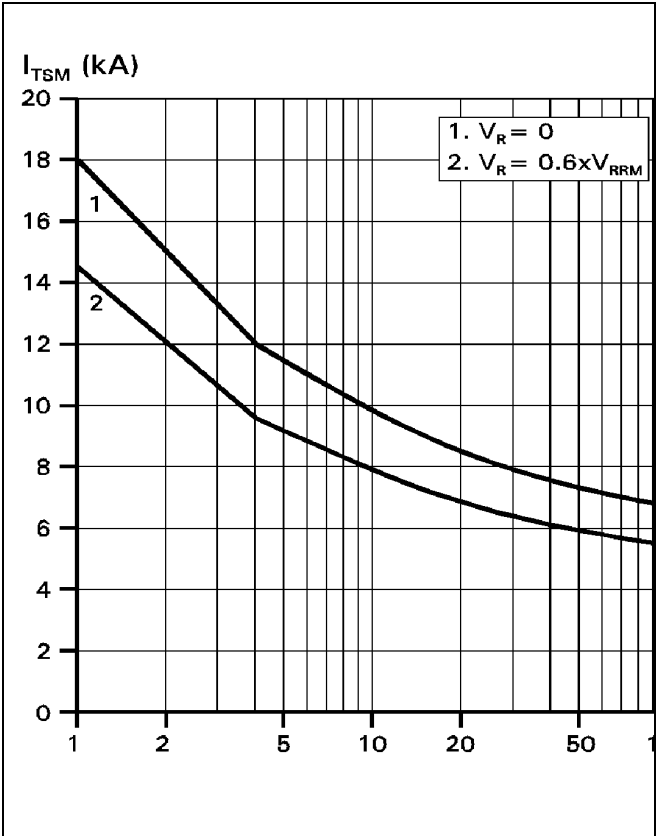


Fig. 7 Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.

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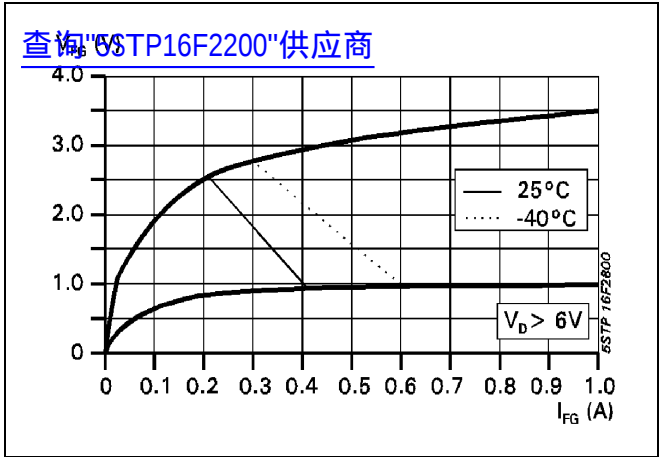


Fig. 8 Gate trigger characteristics.

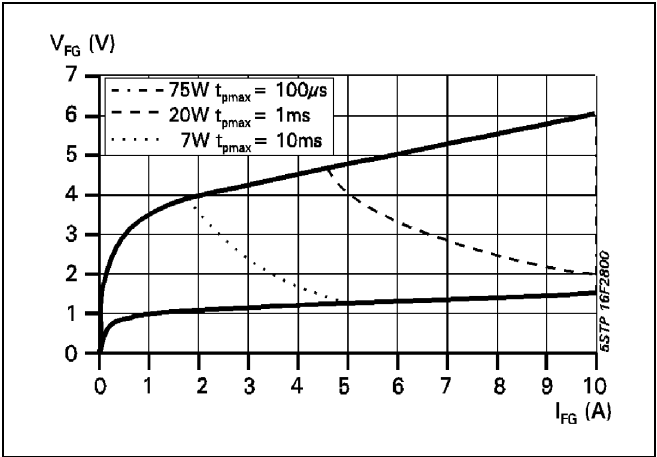


Fig. 9 Max. peak gate power loss.

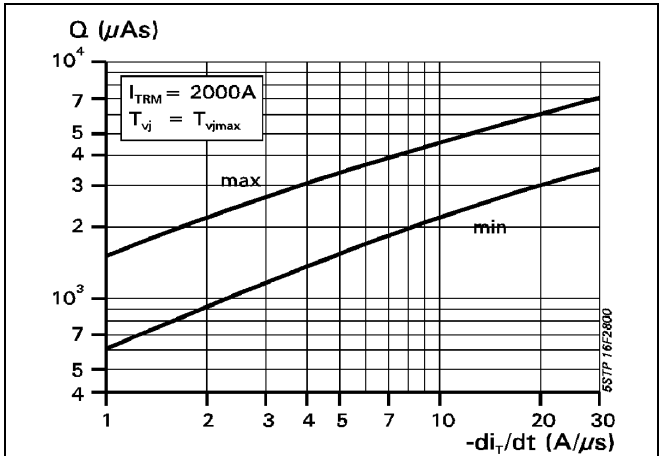


Fig. 10 Recovery charge vs. decay rate of on-state current.

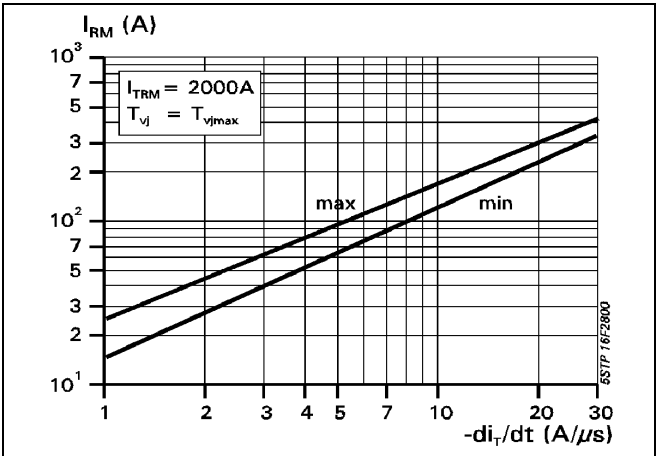


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current.

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